

Multimedia Available: Applied Materials Sets New Benchmark for 300mm High-Volume Manufacturing with Applied Endura2 System

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--(BUSINESS WIRE)--

Applied Materials Inc. today launches a new generation of its acclaimed Applied Endura(R) platform, the Applied Endura(R)2. Based on the industry's most successful semiconductor processing system, the Endura2 platform has 20 percent fewer parts and sets a new standard for clean design that emphasizes reliability, serviceability and overall equipment efficiency for 300mm high-volume manufacturing. Its true modular architecture slashes system manufacturing time by one-third, reducing order lead time and shortening startup time in customer fabs.

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